

SYS-CLEAN[®] SPRAY2.0

SYSTRONIC 

Oven cleaner – ready-to-use

SYS-CLEAN[®] SPRAY2.0 is developed for the manual cleaning of ovens and cleans powerfully stubborn burnt-in dirt.

SYS-CLEAN[®] SPRAY2.0 develops its full power when cleaning heated ovens and oven parts. For manual cleaning the **SPRAY2.0** is pleasant to handle as it has been developed to be uncritical to health, unlike conventional oven cleaners (see labelling & safety data sheet).



Application

Pollution	Suitability
Solder pastes	✓
SMT adhesive or conductive adhesive	✓
Flux	✓ ✓
Oils/fats	✓

Application parameters

Parameter	
Application temperature	Up to 60°C
Cleaning duration approx.	manually
Application Concentration	ready-to-use

✓ ✓ = Excellent ✓ = Optimal ○ = Optional ✗ = Not recommended

Technische Daten

SYS-CLEAN[®] SPRAY2.0 is delivered as a finished mixture.

pH-Value	11,1
Density (at 20°C)	1,004 g/cm ³
Refractive Index (at 20°C)	N.A.
Initial boiling point and boiling range	>100 °C
Flashpoint	>100 °C

Oven cleaner – ready-to-use

Application	
Spray-in-air	✘
Immersion cleaning air agitated	✘
Spray under Immersion	✘
Ultrasonic	✘
Manual cleaning	✓ ✓

✓ ✓ = Excellent ✓ = Optimal ○ = Optional ✘ = Not recommended

Advantages:

SYS-CLEAN[®] SPRAY2.0 is water-based. Thanks to its high flash point, it can also be used on surfaces that have not completely cooled down, unlike solvents.

Use according to label:

1. Shake bottle before use
2. Move spray nozzle to desired position
3. **SYS-CLEAN[®] SPRAY2.0** spray on dirty surface
(ideal surface temperature 30-50°C)
4. Allow the cleaning medium to soak in for a few minutes
5. Wipe with a suitable cloth

Availability:

SYS-CLEAN[®] SPRAY2.0 is available in the following sizes

Item number: 64905473 – 1L

Packaging unit : 12 packages + 3 Sprayheads



Registration, Evaluation and
Authorisation of Chemicals

The product is free of
questionable ingredients
according to the SIN- &
SVHC-Lists



100% compliant with EU
guidelines RoHS 1 & 2,
WEEE